

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT6533289

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| SUBMISSION TYPE: | NEW ASSIGNMENT |
| NATURE OF CONVEYANCE: | ASSIGNMENT |
| CONVEYING PARTY DATA | |
| Name | Execution Date |
| AJAYKUMAR BUNHA | 01/22/2021 |
| ANTONY P. CHACKO | 01/22/2021 |
| YARU SHI | 01/22/2021 |
| QINGPING CHEN | 01/22/2021 |
| PHILIP M. LESSNER | 01/22/2021 |
| RECEIVING PARTY DATA | |
| Name: | KEMET ELECTRONICS CORPORATION |
| Street Address: | KEMET TOWER |
| Internal Address: | ONE EAST BROWARD BLVD., 2ND FLOOR |
| City: | FORT LAUDERDALE |
| State/Country: | FLORIDA |
| Postal Code: | 33301 |
| PROPERTY NUMBERS Total: 1 | |
| Property Type | Number |
| Application Number: | 17167176 |
| CORRESPONDENCE DATA | |
| Fax Number: | |
| <i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i> | |
| Phone: | 864-990-3672 |
| Email: | patents@Patentfsi.com |
| Correspondent Name: | PATENT FILING SPECIALIST INC. |
| Address Line 1: | 16 WELLINGTON AVE. |
| Address Line 4: | GREENVILLE, SOUTH CAROLINA 29609 |
| ATTORNEY DOCKET NUMBER: | 16066.TA.225.4 |
| NAME OF SUBMITTER: | JOSEPH T. GUY |
| SIGNATURE: | /Joseph T. Guy/ |
| DATE SIGNED: | 02/04/2021 |
| Total Attachments: 6 | |

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**Assignment of Rights, Title and Interest in Invention
(Multiple inventors; single assignee)**

Docket No.
16066. TA.225.4

This is an Assignment of the folio wing rights, title and interest: (check all that apply):

- ☒ *United States of America rights, title and interest in the invention*
- ☒ *Foreign rights, title and interest in the invention*
- ☒ *United States Patent Application Serial No.* not yet known
- Date of Execution:* _____ *Date of Filing:* Herwith
- ☒ *United States Provisional Patent Application Serial No.* _____
- ☐ *United States Patent No(s).* _____
- ☐ *International (PCT) Patent Application Serial No.* _____
- ☐ *Other (specify)* _____

Title of the Invention

POLYANION COPOLYMERS FOR USE WITH CONDUCTING POLYMERS IN SOLID ELECTROLYTIC CAPACITORS

Inventors (assignors)

| <i>Name</i> | <i>Address</i> |
|-------------------|---------------------------------------|
| Ajaykumar Bunha | 2835 Kemet Way, Simpsonville SC 29681 |
| Antony P. Chacko | 2835 Kemet Way, Simpsonville SC 29681 |
| Yaru Shi | 2835 Kemet Way, Simpsonville SC 29681 |
| Qingping Chen | 2835 Kemet Way, Simpsonville SC 29681 |
| Philip M. Lessner | 2835 Kemet Way, Simpsonville SC 29681 |
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Assignee

| <i>Name</i> | <i>Address</i> |
|-------------------------------|-----------------------------------------------------------------------------------|
| KEMET Electronics Corporation | KEMET Tower One East Broward Blvd., 2nd Floor Fort Lauderdale, FL 33301 USA |

**Assignment of Rights, Title and Interest in Invention
(Multiple inventors; single assignee)**

**Docket No.
16066. TA.225.4**

Whereas, we, the above-identified Inventors, have invented certain new and useful improvements in the Invention identified above and described in the above-identified patent application(s) and/or patent(s) (hereinafter referred to as "Invention ");

And, whereas we desire to assign our above-identified rights, title and interest in the invention to the above-identified Assignee;


Now, this indenture witnesseth, that for good and valuable consideration, the receipt whereof is hereby acknowledged;

We hereby assign, sell and transfer our above-identified rights, title and interest in said Invention, said application(s) as identified above, including any divisions, continuations, and continuations-in-part thereof, and in and to any and an Letters Patent of the United States, and countries foreign thereto, which may be granted or have granted for said Invention, and in and to any and an reissues and reexaminations thereof, and in and to any and an priority rights, Convention rights, and other benefits accruing or to accrue to us with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, unto said Assignee;

And we hereby authorize and request the Director of the United States Patent and Trademark Office to issue any United States Letters Patent which may issue for said Invention to said Assignee, as assignee of the whole right, title and interest thereto;

And we further agree to sign and execute an necessary and lawful future documents, including applications for foreign patents, for filing divisions, continuations and continuations-in-part of said application for patent, and/or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid Invention, as the Assignee or its Designee(s) may from time to time require and prepare at its own expense.

Inventors' Signatures

| <i>Name</i> | <i>Signature / Date</i> |
|-------------------|-------------------------------------------------------------------------------------------------|
| Ajaykumar Bunha |  2021.Jan.22 |
| Antony P. Chacko | 2021.Jan.22 |
| Yaru Shi | 2021.Jan.22 |
| Qingping Chen | 2021.Jan.22 |
| Philip M. Lessner | 2021.Jan.22 |
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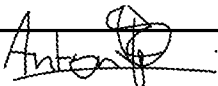
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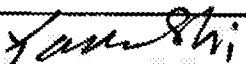
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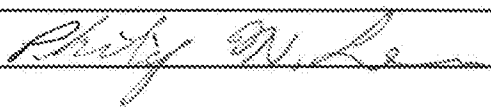
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